

Title (en)

Method for increasing the hydrophilicity of polymeric materials

Title (de)

Verfahren zum Steigern der Hydrophilie polymerer Materialien

Title (fr)

Procédé d'augmentation de l'hydrophilie des matériaux polymériques

Publication

EP 2559806 A1 20130220 (EN)

Application

EP 11006735 A 20110817

Priority

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Abstract (en)

A method for increasing the hydrophilicity of a fibrous or porous polymeric material in a sample comprising said polymeric material, comprises contacting said sample with an oxidizing gas comprising an oxidizing component.

IPC 8 full level

D06L 3/02 (2006.01); **D06L 3/04** (2006.01); **D06L 4/50** (2017.01); **D06M 11/32** (2006.01); **D06M 11/34** (2006.01)

CPC (source: EP)

D06M 11/32 (2013.01); **D06M 11/34** (2013.01)

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